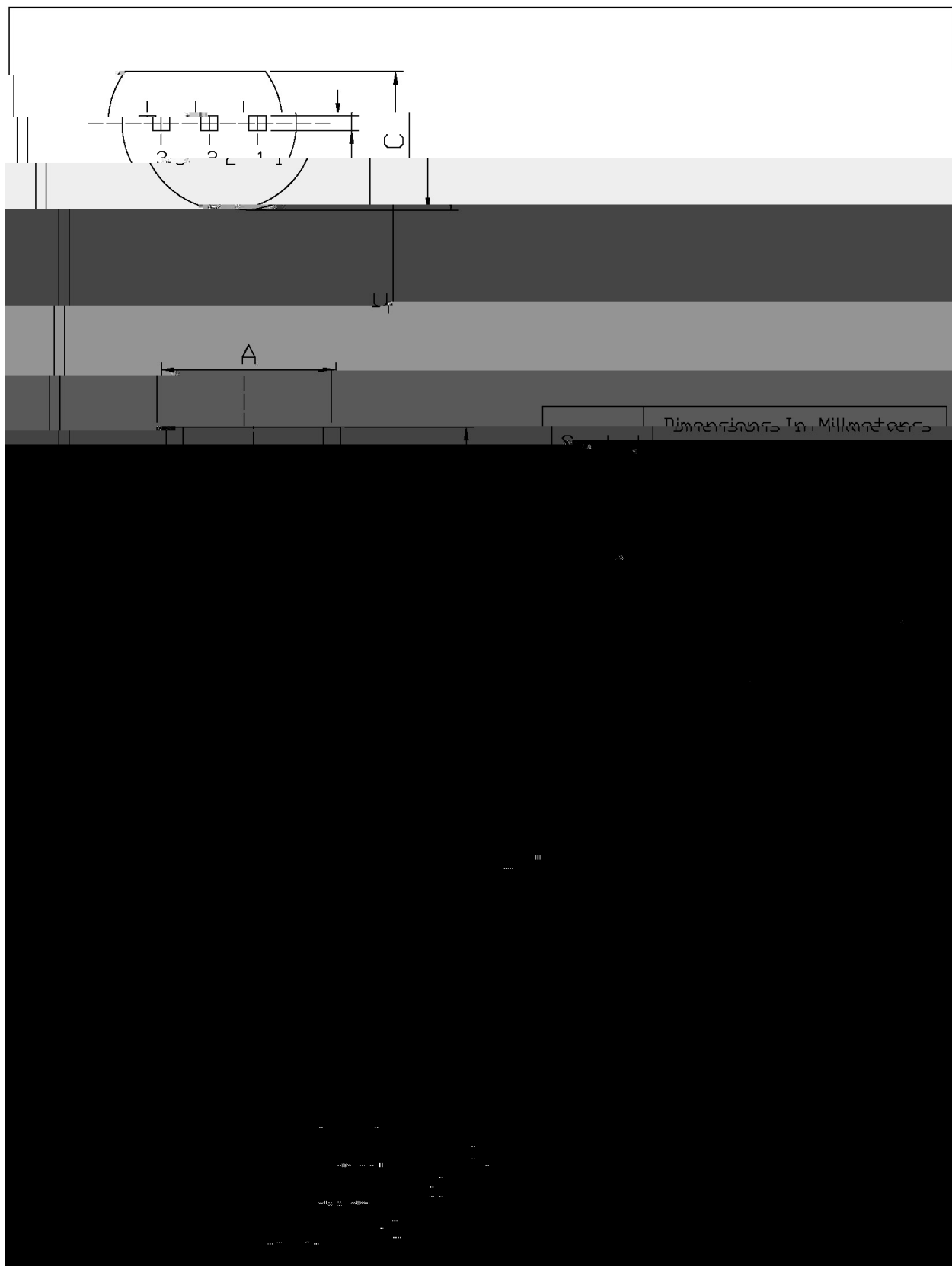


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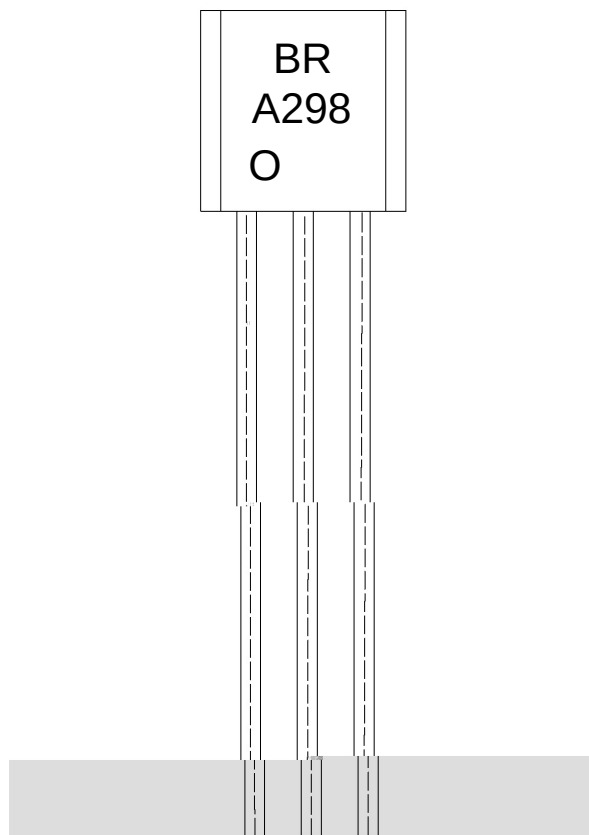
Rev.E Mar.-2016

T O - 92

Unit: mm



/ Marking Instructions



б " X

EU:

№ 3^и ПД

D5<; X

№ 3^и ПД

R:

№ h_{FE} ' 6 ПД

---- X

№ 1 F ъ^и ПД 1 ф 1 F ъ^и ПД

Note:

BR:

Company Code.

A298:

Product Type.

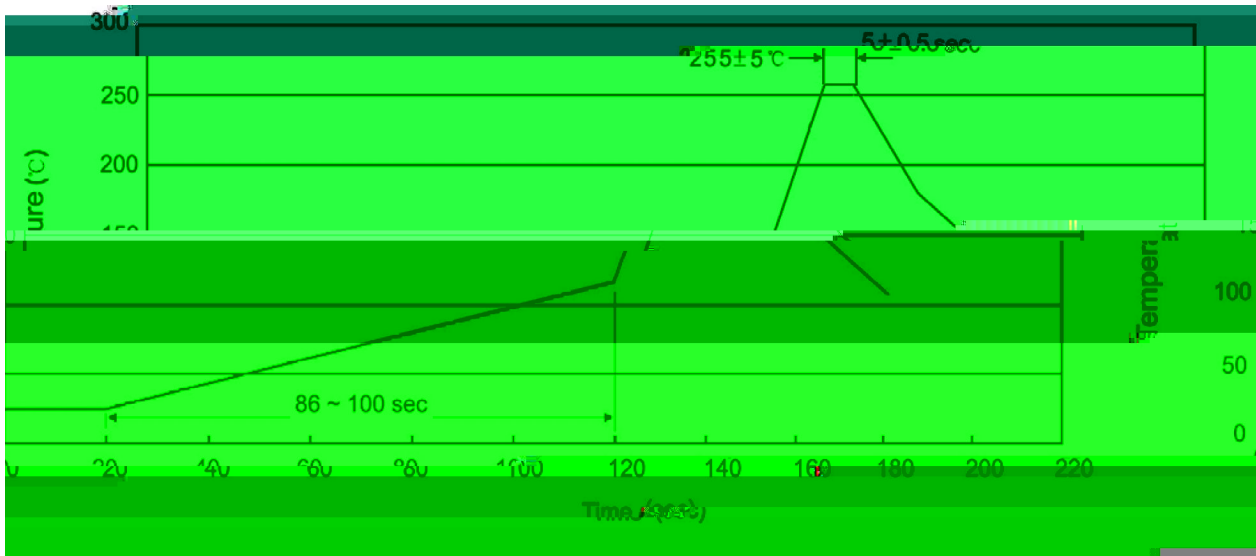
O:

h_{FE} Classifications Symbol

****:

Lot No. Code,code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



说明

1. 预加热: 25~150℃, 时间: 60~90sec;
2. 峰值温度: 255±5℃, 持续时间: 5±0.5sec;
3. 冷却速度: 2~10℃/sec.

Note:

- 1.Preheating:25~150℃, Time:60~90sec.
- 2.Peak Temp.:255±5℃, Duration:5±0.5sec.
3. Cooling Speed: 2~10℃/sec.

/ Resistance to Soldering Heat Test Conditions

温度: 270±5℃ 时间: 10±1 sec. Temp:270±5 Time:10±1 sec

/ Packaging SPEC.

包装形式 / BULK

Package Type	Units					Dimension		(unit mm3)